

BR25G512F-3GE2 Information


For Reference Only

Part Number [BR25G512F-3GE2](#)
Manufacturer Rohm Semiconductor
Category Integrated Circuits (ICs)
[Memory](#)
Description SPI BUS EEPROM
Package 8-SOIC (0.173", 4.40mm Width)
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com


[Request a Quote](#)
Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


BR25G512F-3GE2 Specifications

Manufacturer Part Number	BR25G512F-3GE2
Manufacturer	Rohm Semiconductor
Category	Integrated Circuits (ICs) Memory
Package	8-SOIC (0.173", 4.40mm Width)
Series	-
Memory Type	Non-Volatile
Memory Format	EEPROM
Technology	EEPROM
Memory Size	512Kb (64K x 8)
Memory Interface	SPI
Clock Frequency	10MHz
Write Cycle Time - Word, Page	5ms
Access Time	-
Voltage - Supply	1.8 V ~ 5.5 V
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.173", 4.40mm Width)
Supplier Device Package	8-SOP

[Report errors?](#)

BR25G512F-3GE2 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

BR25G512F-3GE2 Payment Methods



BR25G512F-3GE2 Shipping Methods



If you have any question about BR25G512F-3GE2, please do not hesitate to contact us!

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